50G SFP56 Direct Attach Cable TSSP-PC50G-xxM

General Description

SFP56 Direct Attach Cables are compliant with SFF-8432 and SFF-8402 specifications. Various choices of wire gauge are available from 30 to 26 AWG with various choices of cable length (up to 3m).

Features

- Up to 50Gbps data rate
- Up to 3m transmission
- Hot-pluggable SFP 20PIN footprint
- Compatible with IEEE 802.3bj and IEEE 802.3cd
- Compatible to SFF-8402 and SFF-8432
- Single 3.3V power supply
- Temperature Range: 0 °C to 70 °C
- RoHS Compliant

Applications

- Low EMI radiation Switches, servers and routers
- Data Center networks
- Storage area networks
- High performance computing
- Telecommunication and wireless infrastructure
- Medical diagnostics and networking
- Test and measurement equipment



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Recommended Operation Condition

| Parameter | Symbol | Min | Max | Unit |
|--------------------------------------|---------|-------|-----------|------|
| Operating Case Temperature | Торс | 0 | 70 | degC |
| Storage Temperature | Tst | -40 | 85 | degC |
| Relative Humidity (non-condensation) | RS | 35 | 60 | % |
| Supply Voltage | VCC3 | 3.135 | 3.465 | V |
| Voltage on LVTTL Input | Vilvttl | -0.3 | VCC3 +0.2 | V |
| Power Supply Current | ICC3 | - | 15 | mA |
| Total Power Consumption | Pd | - | 0.05 | W |

Notes:

Stress or conditions exceed the above range may cause permanent damage to the device.

This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not applied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Frequency Domain

| Parameter | Symbol | Min | Typical | Max | Uni | Note |
|--|----------|--------|---------|-------|-----|----------------------|
| Differential Impedance | TDR | 90 | 100 | 110 | Ώ | - |
| Insertion loss | SDD21 | -16.06 | - | - | dB | At 13.28 GHz |
| Differential Return Loss | SDD11 | - | - | See 1 | J. | At 0.05 to 4.1 GHz |
| | SDD22 | - | - | See 2 | dB | At 4.1 to 19 GHz |
| Common-mode to common- | SCC11 | - | - | -2 | dB | At 0.2 to 19 GHz |
| Differential to common-mode return loss | SCD11 | - | - | See 3 | dB | At 0.01 to 12.89 GHz |
| | SCD22 | - | - | See 4 | | At 12.89 to 19 GHz |
| Differential to common Mode Conversion Loss | SCD21-IL | - | - | -10 | dВ | At 0.01 to 12.89 GHz |
| | | - | - | See 5 | | At 12.89 to 15.7 GHz |
| | | - | - | -6.3 | | At 15.7 to 19 GHz |

Notes:

Reflection Coefficient given by equation SDD11(dB) < -16.5 + 2 \times SQRT(f), with f in GHz

Reflection Coefficient given by equation SDD11(dB) < -10.66 + 14 \times log10(f/5.5), with f in GHz

Reflection Coefficient given by equation SCD11(dB) < -22 + (20/25.78)*f, with f in GHz

Reflection Coefficient given by equation SCD11(dB) $< -15 + (6/25.78)^*f$, with f in GHz

Reflection Coefficient given by equation SCD21(dB) < -27 + (29/22)*f, with f in GHz



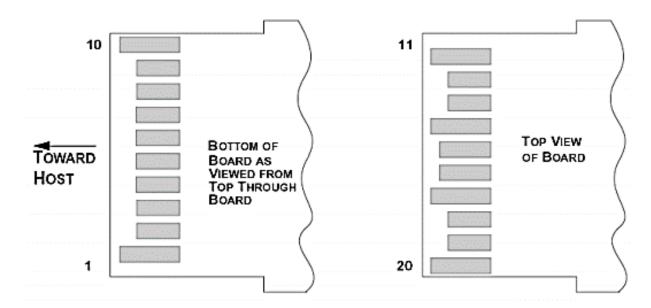
Pin Definition

| Pin | Symbol | Name/Description | |
|-----|--------------|---|--|
| 1 | VEET [1] | Transmitter Ground | |
| 2 | Tx_FAULT [2] | Not used | |
| 3 | Tx_DIS [3] | Not used | |
| 4 | SDA [2] | 2-wire Serial Interface Data Line | |
| 5 | SCL [2] | 2-wire Serial Interface Clock Line | |
| 6 | MOD_ABS [4] | Module Absent. Grounded within the module | |
| 7 | RS0 [5] | Not used | |
| 8 | RX_LOS [2] | Loss of Signal indication. Logic 0 indicates normal operation | |
| 9 | RS1 [5] | Not used | |
| 10 | VEER [1] | Receiver Ground | |
| 11 | VEER [1] | Receiver Ground | |
| 12 | RD- | Receiver Inverted DATA out. AC Coupled | |
| 13 | RD+ | Receiver DATA out. AC Coupled | |
| 14 | VEER [1] | Receiver Ground | |
| 15 | VCCR | Receiver Power Supply | |
| 16 | VCCT | Transmitter Power Supply | |
| 17 | VEET [1] | Transmitter Ground | |
| 18 | TD+ | Transmitter DATA in. AC Coupled | |
| 19 | TD- | Transmitter Inverted DATA in. AC Coupled | |
| 20 | VEET [1] | Transmitter Ground | |

Notes:

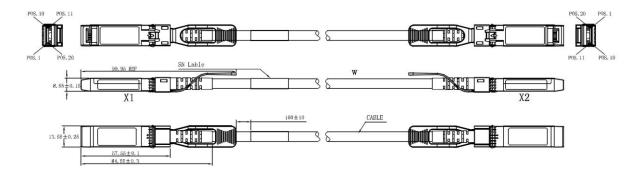
- $1. \\ \\ \text{Module circuit ground is isolated from module chassis ground within the module.}$
- 2...should be pulled up with 4.7k-10k ohms on host board to a voltage between 3.15V and 3.6V.
- $3.Tx_Disable$ is an input contact with a 4.7 k Ω to 10 k Ω pullup to VccT inside the module.
- 4.Mod_ABS is connected to VeeT or VeeR in the SFP+ module. The host may pull this contact up to Vcc_Host with a resistor in the range $4.7 \text{ k}\Omega \text{ to} 10 \text{ k}\Omega.\text{Mod}_{-}\text{ABS}$ is asserted "High" when the SFP+ module is physically absent from a host slot.
- 5. RSO and RS1 are module inputs and are pulled low to VeeT with > 30 k Ω resistors in the module.





Mechanical Dimensions

The connector is compatible with the SFF-8432 specification.



Mechanical Specifications

| Parameter | Minimum | Typical | Maximum | Unit |
|-------------------------|---------|---------|---------|--------|
| Cable Diameter (26AWG) | - | 0.220 | - | Inches |
| Bend Radius (26AWG) | 1.102 | - | - | Inches |
| Cable Diameter (28AWG) | - | 0.185 | - | Inches |
| Bend Radius (28AWG) | 0.925 | - | - | Inches |
| Cable Diameter (30 AWG) | - | 0.181 | - | Inches |
| Bend Radius (30 AWG) | 0.906 | - | - | Inches |
| Within Pair Skew | - | - | 100 | ps/10m |
| Cable Insertion Loss | - | 15.43 | - | dB/5m |
| Bulk Cable Time Delay | - | - | 5.2 | ns/m |
| Bulk Cable Impedance | 95 | 100 | 105 | Ohms |



| Insertion Force | - | - | 40 | N |
|------------------|-----------|---|----|---|
| Withdrawal Force | - | - | 30 | N |
| Retention Force | 90 | - | - | N |
| Durability | 50 Cycles | - | - | - |

Ordering Information

50G SFP56 Copper Cable Assemblies, Passive.

| P/N | Length | Data Rate | AWG | Length Tolerance |
|----------------|--------|-----------|-------|------------------|
| TSSP-PC50G-01M | 1M | 50G | 26/30 | +3.5/-3.5cm |
| TSSP-PC50G-02M | 2M | 50G | 26/30 | +3.5/-3.5cm |
| TSSP-PC50G-03M | 3M | 50G | 26/30 | +4/-4cm |